

Small Signal Schottky Diode



FEATURES

- Integrated protection ring against static discharge
- Very low forward voltage
- AEC-Q101 qualified
- Material categorization:
For definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

MECHANICAL DATA

Case: MicroMELF

Weight: approx. 12 mg

Cathode band color: black

Packaging codes/options:

TR3/10K per 13" reel (8 mm tape), 10K/box

TR/2.5K per 7" reel (8 mm tape), 12.5K/box

APPLICATIONS

- Applications where a very low forward voltage is required

PARTS TABLE

PART	TYPE DIFFERENTIATION	ORDERING CODE	INTERNAL CONSTRUCTION	REMARKS
BAS385	$V_R = 30\text{ V}$	BAS385-TR3 or BAS385-TR	Single diode	Tape and reel

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		V_R	30	V
Peak forward surge current	$t_p = 10\text{ ms}$	I_{FSM}	5	A
Repetitive peak forward current	$t_p \leq 1\text{ s}$	I_{FRM}	300	mA
Forward continuous current		I_F	200	mA
Average forward current	$V_{RWM} = 25\text{ V}$	I_{FAV}	200	mA

THERMAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Junction to ambient air	On PC board 50 mm x 50 mm x 1.6 mm	R_{thJA}	320	K/W
Junction temperature		T_j	125	$^{\circ}\text{C}$
Storage temperature range		T_{stg}	- 65 to + 150	$^{\circ}\text{C}$

ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_F = 0.1\text{ mA}$	V_F			240	mV
	$I_F = 1\text{ mA}$	V_F			320	mV
	$I_F = 10\text{ mA}$	V_F			400	mV
	$I_F = 30\text{ mA}$	V_F			500	mV
	$I_F = 100\text{ mA}$	V_F			800	mV
Reverse current	$V_R = 25\text{ V}$, $t_p = 300\text{ }\mu\text{s}$	I_R			2.3	μA
Diode capacitance	$V_R = 1\text{ V}$, $f = 1\text{ MHz}$	C_D			10	pF

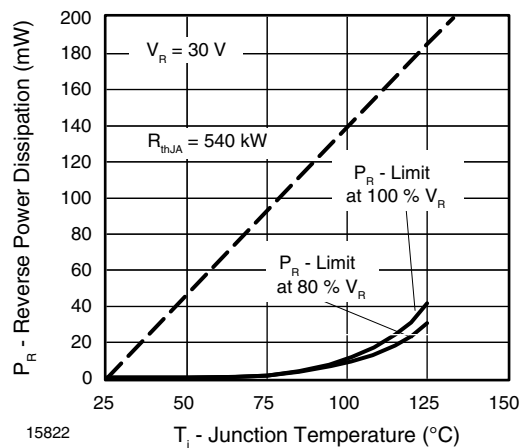
TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)


Fig. 1 - Max. Reverse Power Dissipation vs. Junction Temperature

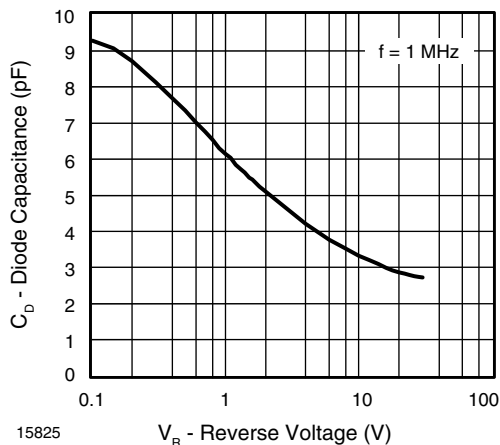


Fig. 4 - Diode Capacitance vs. Reverse Voltage

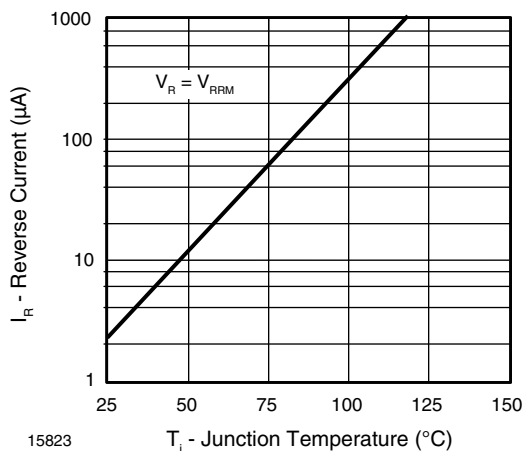


Fig. 2 - Reverse Current vs. Junction Temperature

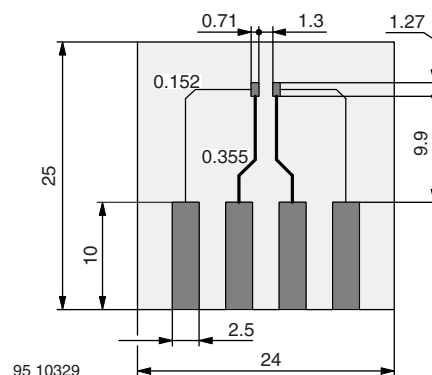
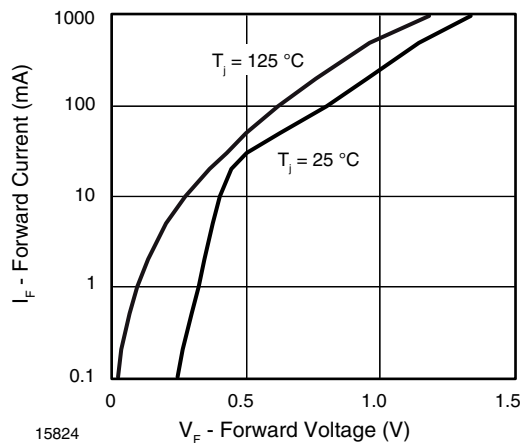
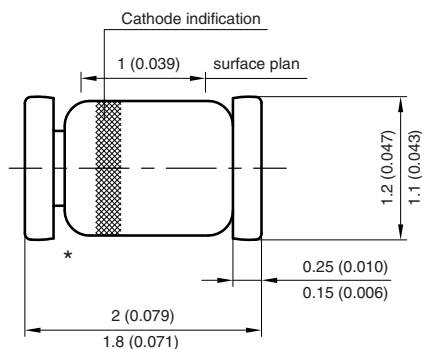
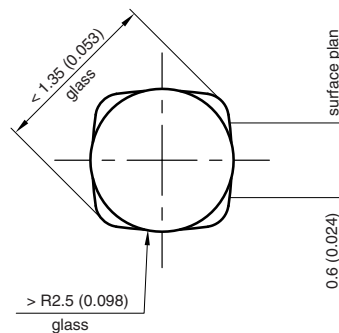

Fig. 5 - Board for R_{thJA} Definition (in mm)


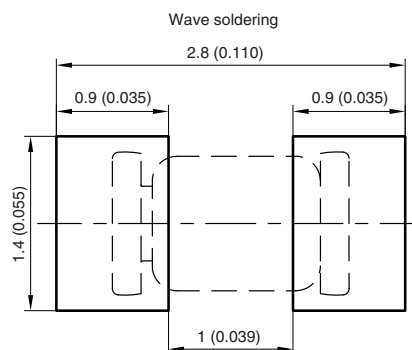
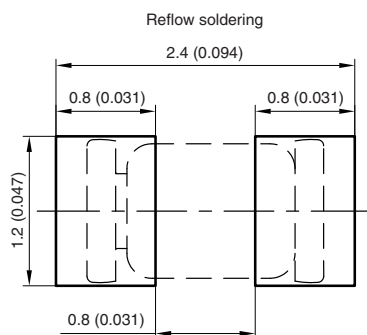
Fig. 3 - Forward Current vs. Forward Voltage

PACKAGE DIMENSIONS in millimeters (inches): **MicroMELF**


* The gap between plug and glass can be either on cathode or anode side



Foot print recommendation:



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 96 12072



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